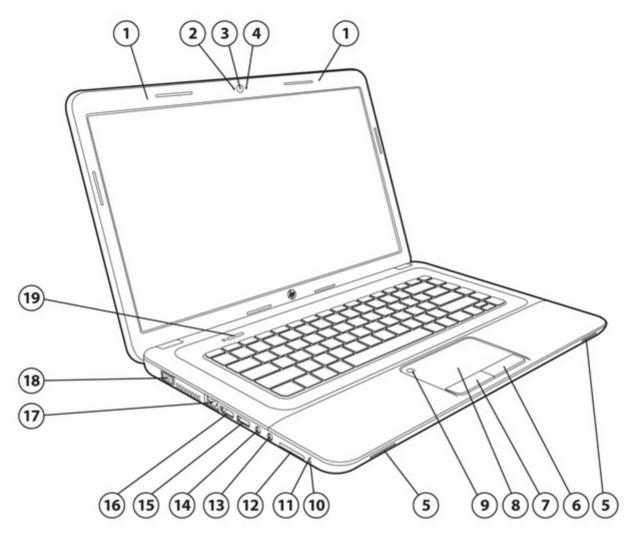
Overview



- 1. WLAN antennas (select models only)
- 2. Webcam light
- 3. Webcam
- 4. Internal microphone
- 5. Stereo speakers
- 6. Right TouchPad button
- 7. Left TouchPad button
- 8. Touchpad with scroll zone
- 9. TouchPad on/off button
- 10. Hard drive light

- 11. Power light
- 12. Digital media slot
- 13. Audio-out (headphone) jacks
- 14. Audio-in (microphone) jack
- 15. USB port
- 16. HDMI port
- 17. RJ-45 (Ethernet)
- 18. External monitor port
- 19. Power button



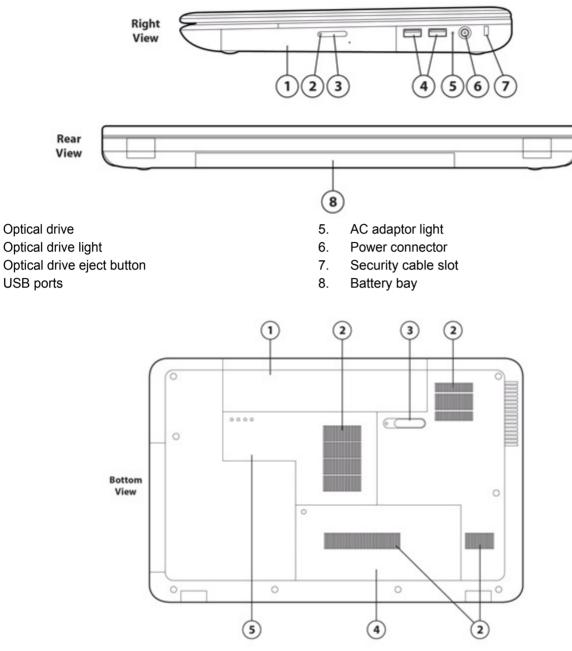
Overview

1.

2.

3.

4.



- 1. Battery bay
- 2. Vents
- 3. Battery release latch

4. Hard drive bay compartment

5. Wireless compartment, and memory module compartment, keyboard screw, and optical drive bay.



Overview

At A Glance

- Windows 8 versions, Ubuntu Linux, FreeDOS 2.0*
- VISION Technology with AMD Mobility Radeon™ HD
- Durable, sophisticated design with smooth surfaced charcoal color.
- Full-sized keyboard with action keys enabling functions directly
- HDMI port for connecting to high-resolution displays
- Integrated HD webcam, integrated microphone
- Integrated 802.11 b/g/n wireless LAN module**
- Bluetooth[™] 2.1 or Bluetooth[™] 4.0 + High Speed (HS)**
- 15.6" diagonal LED-backlit HD anti-glare display

* Operating system options vary by country.

** Select models only (BT4.0 HS supports under Windows 8 OS only, BT2.1 supports under Linux)



Features

OPERATING SYSTEM

Preinstalled

Windows 8 64* Windows 8 Pro 64* Ubuntu Linux FreeDOS 2.0

* Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See http://www.microsoft.com for details.

PROCESSOR

AMD

AMD Dual Core E2-2000 APU with Radeon[™] HD 7340 Graphics (1.75 GHz, 1 MB L2 cache, 2 cores)* AMD Dual Core E2-1800 APU with Radeon[™] HD 7340 Graphics (1.7 GHz, 1 MB L2 cache, 2 cores)* AMD Dual Core E1-1500 APU with Radeon[™] HD 7310 Graphics (1.48 GHz, 1 MB L2 cache, 2 cores)* AMD Dual Core E1-1200 APU with Radeon[™] HD 7310 Graphics (1.4 GHz, 1 MB L2 cache, 2 cores)*

* This system requires a separately purchased 64-bit operating system and 64-bit software products to take advantage of the 64-bit processing capabilities of AMD technology. Multi-core processing with AMD technology is designed to improve performance of this system. Given the wide range of SW applications available, performance will vary. AMD's numbering is not a measurement of clock speed.

CHIPSET

AMD A68M Integrated SOC FCH for Kabini Architecture

GRAPHICS

AMD Radeon[™] HD 7310 (AMD Dual Core E1-1200 APU and E1-1500 APU) AMD Radeon[™] HD 7340 (AMD Dual Core E2-1800 APU and E2-2000 APU)

DISPLAY

Internal

15.6"diagonal LED-backlit HD anti-glare (1366 x 768)

External

Up to 32-bit per pixel color depth

VGA

Port supports resolutions up to 2048 x 1536 external resolution @75 Hz

HDMI*

1.3 port supports up to 1080p, 1920 x1080 at 60Hz and 1920 x1200 0 60Hz DVI Mode

* HD content required to view HD images.

** HDMI cable sold separately.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.



Features

STORAGE AND DRIVES

Primary Storage Bay Hard Drives 320/500/640/750 GB 5400 rpm SMART SATA II DriveGuard The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive

NOTE: For hard drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 8) of system disk is reserved for the system recovery software.

OPTICAL DRIVES

Fixed 12.7 mm SATA Optical Drive

DVD+/-RW SuperMulti DL* Drive Weight saver

* Double-layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. Note that DVD-RAM cannot read or write to 2.6 GB single-sided/5.2 GB double-sided - version 1.0 media. Don't copy copy-right protected materials.

MEMORY

Standard

DDR3 SDRAM (1600 MHz)* or DDR3/3L SDRAM (1600 MHz)* Two SODIMM slots supporting single channel 2048 MB and 4096 MB SODIMMs Standard memory up to 6144 MB

Maximum

Upgradeable to 8192 MB with optional 2048/4096 MB SODIMMs in slots 1 and 2

* Maximum memory speed supported by the system may be 1333 MHz or 1066 MHz.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. With Windows Starter 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

NETWORKING/COMMUNICATIONS

Wireless

Optional 802.11b/g/n (1x1) wireless LAN module¹

Qualcomm 802.11 b/g/n (1x1) wireless LAN module² (Windows 8, Ubuntu Linux and FreeDOS 2.0 only) Ralink 802.11 b/g/n (1x1) + Bluetooth[™] 4.0 combo² (Windows 8, Ubuntu Linux and FreeDOS 2.0 only) Bluetooth[™] 2.1³ or Bluetooth[™] 4.0⁴ + High Speed (HS)

Communications

Realtek Ethernet (10/100/1000 NIC)

1. Sold separately or as an optional feature.

2. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.

3. Bluetooth $^{\text{TM}}$ 2.1 is available on Linux operating system.

4. Bluetooth[™] 4.0 is available on Windows 8 operating system only.

NOTE: In countries where 802.11n is not allowed, this capability is not enabled.



Features

AUDIO/MULTIMEDIA

Audio

High Definition Audio support Integrated Altec Lansing Stereo Speakers Integrated microphone

Webcam

Integrated HD* Webcam**

- Supports videoconferencing and still image capture
- Improved quality for video streaming and still image capture (1280x720 resolution)
- Up to 30 frames/sec
- Fixed focus lens

* HD content required to view HD images.

** Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

The 100% compatible keyboard features a, industry standard, full-pitch key layout with features such as the isolated inverted-T cursor control keys, editing keys, both left and right control and alt keys, and 12 function keys. International key layouts are available. Other features include hotkeys for instant access to, brightness, etc. 19-mm x 19-mm key pitch (center-to-center spacing), 2.2-mm stroke, comfort-dished keycaps, and bright key legends for improved visibility in low light conditions.

Pointing Devices

Touchpad with 2-piece pick button with left and right click functions

Buttons and Function Keys

Multi-touch gestures supported On/off button

SOFTWARE AND SECURITY

Preinstalled Software with Windows Operating System

Buy Office Recovery Manager Installer Cyberlink Youcam DE Cyberlink Power DVD (available on select models) Symantec Norton ™ Internet Security 2013* Getting Started with Win8

Security

Security Lock slot (lock must be purchased separately)

* Internet access required. This product includes Norton software. First 60 days included. Subscription required for live updates afterward.

For more information on HP security solutions refer to: http://www.hp.com/go/security.



Features

POWER

Power Supply

External 65W HP AC adapter

Primary Battery

HP 6-cell (47 WHr) Li-Ion battery Battery life up to TBD hours*

System Standby Time

Up to 1 week

* Testing conducted by HP consisting of full battery discharge while running a series of productivity scripts against the following applications (which may or may not be included with your particular product): Adobe ® AcrobatReader 7.0, Adobe® Illustrator® CS2, Adobe® Photoshop® CS2, Apple® Quicktime 7.1, Intervideo® WinDVD® 8, Macromedia® Flash 8, Microsoft® Office® 2003 Pro, Microsoft® Project 2003, and Winzip® 10.0. Prior to testing, the system was fully charged and set to display brightness of 60 nits, auto dim disabled, wireless off, suspend and hibernate disabled and all other programs, utilities, and services not essential to running the computer system or battery life test. Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage.

NOTE:Fast Charge recharges your battery up to 90% within 90 minutes when the system is off. The HP Fast Charge is only for 6 cell/47 WHr battery pack.

Power Conservation

Hibernation* Standby* ACPI compliance*

* Only Linux will feature power conservation.

WEIGHTS & DIMENSIONS

Weight

Starting at 5.39 lb (2.45 kg)

Dimensions (w x d x h) 14.80 x 9.72 x 1.41 in 37.6 x 24.7 x 3.58 cm

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes 6-cell battery, hard drive, 1 GB memory, and optical drive.



Features

PORTS/SLOTS

Ports

VGA – One HDMI* – One Stereo microphone in – One Stereo headphone/line out – One Power Connector – One RJ-45 (Ethernet) – One USB 2.0 – Three

Digital Media Slots

Supports SD (Secure Digital) Supports mini versions with adapter

* HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers limited 1-year warranty options depending on country;

1 year limited warranty on primary battery. On-site service and warranty upgrades are also available. HP Care Pack Services* extend service contracts beyond the standard warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack.

* Service levels and response times for HP Care Packs may vary depending on your geographic location. Restrictions and limitations apply. Service starts at date of hardware purchase. For details, visit www.hp.com/go/lookuptool

NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp



Technical Specifications

SYSTEM UNIT

Dimensions	14.8 x 9.72 x 1.41 in
(w x d x h)	37.6 x 24.7 x 3.58 cm
Weight	Starting at 5.39 lb (2.45 kg)

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes 6-cell battery, hard drive, 1 GB memory, and optical drive.

componente: weight men	addo o con battory, nara a	inve, i eb memory, and optical anve.
Stand-Alone Power Requirements (AC	Nominal Operating Voltage	18.5/19.5V
Power)	Average Operating Power	Integrated graphics: 12.55 W**AMD E-series platform
	Max Operating Power	< 65 W
Temperature	Operating	32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (writing optical)
	Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	Operating	10% to 90%, non-condensing
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	Operating	40 G, 2 ms, half-sine
	Non-operating	200 G, 2 ms, half-sine
Random Vibration	Operating	0.75 grms
	Non-operating	1.50 grms
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Planned Industry	UL	Yes
Standard Certifications	CSA	Yes
Certifications	FCC Compliance	Yes
	ENERGY STAR®	Select models*
	EPEAT	Registered Silver in United States**
	ICES	Yes
	Australia / NZ A-Tick Compliance	Yes
	CCC	Yes
	Japan VCCI Compliance	Yes
	КС	Yes
	BSMI	Yes
	CE Marking Compliance	Yes
	BNCI or BELUS	Yes
	CIT	Yes
	GOST	Yes
	Saudi Arabian Compliance (ICCP)	Yes
	SABS	Yes
	UKRSERTCOMPUTER	Yes



Technical Specifications

* Configurations of the HP 255 that are ENERGY STAR qualified are identified as HP 255 ENERGY STAR on HP websites and on www.energystar.gov.

** EPEAT registration varies by country. See <u>www.epeat.net</u> for registration status by country. EPEAT status listed above applies to U.S.

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.

DISPLAY

15.6-inch LED HD (1366 x 768) Anti-glare	Active Area (w x h) Diagonal Size Surface Treatment	13.54 x 7.59 in (34.4 x 1 15.6 in (39.6cm) Anti-glare	9.4 cm)
	Contrast Ratio	300:1 (min)	
	Refresh Rate	60 Hz	
	Brightness	200 nit (typical)	
	Pixel Resolution	Pitch	0.252 mm
		Format	1366 x 768
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	101 ppi	
	Viewing Angle	±40° Horizontal, ±10°/-30 40/40/30/10 (Left/Right/E	· · · · ·

STORAGE AND DRIVES

Internal Storage				
750 GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)		
Hard Drive	Capacity	750 GB		
	Height	0.37 in (9.5 mm)		
	Width	2.75 in (70 mm)		
	Interface	ATA-8, SATA 2.6, 3.0 G	b/s, NCQ	
	Transfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)	
	Seek Time (typical reads, including settling)	Single Track	3 ms	
		Average	13 ms	
		Maximum	24 ms	
	Rotational Speed	5400 rpm		
	Logical Blocks	1,465,149,168		
	Operating Temperatur	e 32° to 140° F (0° to 60°	C) [case temp]	
	Features	ATA Security		



Technical Specifications

640 CB 5400 mm SATA	Drive Weight	0.22 lb (101 c)		
640 GB 5400 rpm SATA Hard Drive	-	0.22 lb (101 g)		
	Capacity	640 GB		
	Height	0.37 in (9.5 mm)		
	Width	2.75 in (70 mm)		
	Interface	ATA-8, SATA 2.6, 3.0 GI	o/s, NCQ	
	Transfer Rate	Synchronous (maximum)	150 MB/s (Drive Capability)	
	Seek Time	Single Track	3 ms	
	(typical reads, including	Average	13 ms	
	settling)	Maximum	24 ms	
	Rotational Speed	5400 rpm		
	Logical Blocks	1,250,263,728		
	-	e 32° to 140° F (0° to 60° (C) [case temp]	
	Features	ATA Security		
		, , , , , , , , , , , , , , , , , , ,		
500 GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)		
Hard Drive	Capacity	500 GB		
	Height	0.37 in (9.5 mm)		
	Width	2.75 in (70 mm)		
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ		
	Transfer Rate	Synchronous	150 MB/s (Drive Capability)	
		(maximum)	130 MB/S (Drive Capability)	
	Seek Time	Single Track	3 ms	
	(typical reads, including	Single Track Average	3 ms 13 ms	
		-		
	(typical reads, including	Average	13 ms	
	(typical reads, including settling)	Average Maximum	13 ms	
	(typical reads, including settling) Rotational Speed Logical Blocks	Average Maximum 5400 rpm	13 ms 24 ms	
	(typical reads, including settling) Rotational Speed Logical Blocks	Average Maximum 5400 rpm 976,773,168	13 ms 24 ms	
	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° 0	13 ms 24 ms	
320 GB 5400 rpm SATA	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° 0	13 ms 24 ms	
320 GB 5400 rpm SATA Hard Drive	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° 0 ATA Security	13 ms 24 ms	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° (ATA Security 0.22 lb (101 g)	13 ms 24 ms	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° (ATA Security 0.22 lb (101 g) 320 GB	13 ms 24 ms	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm)	13 ms 24 ms C) [case temp]	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm) 2.75 in (70 mm)	13 ms 24 ms C) [case temp]	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 GB Synchronous (maximum)	13 ms 24 ms C) [case temp]	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 GB Synchronous	13 ms 24 ms C) [case temp] o/s, NCQ 150 MB/s (Drive Capability)	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Transfer Rate Seek Time	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 Gł Synchronous (maximum) Single Track	13 ms 24 ms C) [case temp] o/s, NCQ 150 MB/s (Drive Capability) 3 ms	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including settling)	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 GB Synchronous (maximum) Single Track Average Maximum	13 ms 24 ms C) [case temp] o/s, NCQ 150 MB/s (Drive Capability) 3 ms 13 ms	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including settling) Rotational Speed	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 GB Synchronous (maximum) Single Track Average Maximum 5400 rpm	13 ms 24 ms C) [case temp] o/s, NCQ 150 MB/s (Drive Capability) 3 ms 13 ms	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including settling) Rotational Speed Logical Blocks	Average Maximum 5400 rpm 976,773,168 e 32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 GB Synchronous (maximum) Single Track Average Maximum 5400 rpm 625,142,448	13 ms 24 ms C) [case temp] o/s, NCQ 150 MB/s (Drive Capability) 3 ms 13 ms 24 ms	
•	(typical reads, including settling) Rotational Speed Logical Blocks Operating Temperature Features Drive Weight Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including settling) Rotational Speed Logical Blocks	Average Maximum 5400 rpm 976,773,168 e32° to 140° F (0° to 60° C ATA Security 0.22 lb (101 g) 320 GB 0.37 in (9.5 mm) 2.75 in (70 mm) ATA-8, SATA 2.6, 3.0 GB Synchronous (maximum) Single Track Average Maximum 5400 rpm	13 ms 24 ms C) [case temp] o/s, NCQ 150 MB/s (Drive Capability) 3 ms 13 ms 24 ms	

Optical Drives

Technical Specifications

DVD+/-RW SuperMulti DL Drive	Access Times	Random	<140ms CD (typical) < 160 ms DVD (typical)
	Max Data Transfer Rat		
		8X DVD	
		24X CD-R	
		24X CD-RW	
		8X DVD+R	
		8X DVD+RW	
		8X DVD-R	
		6X DVD-RW	
		5X DVD-RAM	
	Transfer Mode	UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read	CD-I Bridge (Photo-CD, EXTRA, Portfolio, CD-R,	ROM, CD-ROM XA, MIXED MODE CD, CD-I, Video CD), Multisession CD (Photo-CD, CD- , CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, 8), DVD-R, DVD-RW, DVD+R, DVD+RW, DVD-
	Supported Media (write	e)CD-R, CD-RW, DVD+R, DVD+R DL, DVD-R DL	, DVD+RW, DVD-R, DVD-RW, DVD-RAM,
	Max Media Capacity (read)	8.5 GB	
	Max Media Capacity (write)	8.5 GB	
	Transport	Tray Loading	

NETWORKING/COMMUNICATIONS

Networking		
Integrated Realtek Ethernet Features RTL8161FH-CG 10/100/1000 NIC		 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13- 14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (100BASE-T; IEEE 802.3ab; IEEE 802.3 clauses 21-30) (Support in RTL8161FH-CG only) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable
	Power Management	ACPI compliant - multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Large send offload and Giant send offload Receiving Side Scaling
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot



Technical Specifications

	Interface NIC Device Driver Name	Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status PCI Express 1.1 x1 to fully support ASPM L0s/L1 and CLKREQ Realtek PCIe FE Ethernet Family Controller
Communications		
Qualcomm 802.11b/g/n WiFi Adapter	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Win7, (details at: http://www.hp.com/go/notebooks/WLAN)
	Frequency Band	2.402 - 2.482 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n150Mbps for MCS7
	Frequency Support	20 MHz: 2.4 GHz bands
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM
	Security ¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST.
		Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 5) with Microsoft Windows 7only.
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power ²	13.5 dBm, minimum
	Power Consumption	Idle associated: 250 mW avg (CLKREQ enabled) Idle unassociated: 100 mW avg Transmit/Receive channel: 2.0 /1.6 W
	Power Management	ACPI compliant power management 802.11 compliant power saving mode
	Receiver Sensitivity ³	11b:-88dBm@11Mbps, 11g:-74 dBm@54Mbps, 11n:-70dBm@72.Mbps.
	Antenna type	High efficiency dual antenna with spatial diversity, usually mounted in the display enclosure
	Form Factor	PCI-Express Half-MiniCard
	Weight	4 g
	Dimensions	3.3 x 26.65 x 29.85 mm
	Operating Voltage	3.3v +/- 9%



Technical Specifications

Ralink 802.11b/g/n Bluetooth 4.0 Combo

Card

	Temperature	Operating Non-operating	-10° to 70° C -40° to 80° C
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
	LED Activity	Amber LED on-Radio OF	F; White LED on-Radio ON
	 Maximum output po Receiver sensitivity 	ower may vary by country	tes on supported security features. according to local regulations. error rate of 8% for 802.11b (CCK modulation) (OFDM modulation).
	Microsoft Windows XP. W	/LAN may also be compar ier IHV extensions require	Cisco Compatible Extensions support with tible with certain third-party software of for Cisco Compatible Extensions support for
I	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n	
	Interoperability		ions Program compliant with Microsoft p://www.hp.com/go/notebooks/WLAN)
	Frequency Band	2.402 – 2.482 GHz	
	Data Rates	802.11b: 1, 2, 5.5, 11 Mb 802.11g: 6, 9, 12, 18, 24, 802.11n: 150Mbps for MC	36, 48, 54 Mbps
	Modulation	Direct Sequence Spread DBPSK, DQPSK, CCK, C	Spectrum DFDM, BPSK, QPSK, 16-QAM, 64-QAM
	Security ¹		WEP, WPA, WPA2, hardware-accelerated on types EAP-TLS, EAP-TTLS, PEAP-GTC, P, EAP-FAST. WAPI
		Aironet infrastructure proc	y Features (proven compatibility with Cisco ducts through the Cisco Compatible sion 5) with Microsoft Windows Vista and XP
	Sub-channels	Multinational support with local regulations.	rfrequency bands and channels compliant to
	Media Access Protocol	CSMA/CA (Collision Avoi	dance) with ACK
	Network Architecture Models	Ad-hoc (Peer to Peer)	int Deswined)
	Roaming	Infrastructure (Access Po	paming between access points
	Output Power (for	13.5dBm , minimum	
	CCK) ²	, -	
	Power Consumption	Idle associated: 250 mW Idle unassociated: 150 m Transmit: 2.0 W (max) Receive: 2.0 W (max)	
	Power Management	ACPI compliant power ma 802.11 compliant power s	•



Technical Specifications

Receiver Sensitivity ³	11b:-88dBm@11Mbps, 11g:-74 dBm@54Mbps, 11n:-70dBm@72.Mbps.	
Antenna type	High efficiency dual antenna with spatial diversity, mounted in the display enclosure	
Form Factor	PCI-Express Half-MiniCa	ard
Weight	6 g	
Dimensions	3.3 x 26.65 x 29.85 mm	
Operating Voltage	3.3v +/- 10%	
Temperature	Operating Non-operating	14° to 149° F (-10° to 65° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Off – Radio OFF; S	olid LED On – RadioON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

NOTE: WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista and Win7.

Bluetooth Specification

V4.0 High Speed, V2.1+	EDR, backwards compatible with V1.1, 1.2 and 2.0
Number of Available Channels	79 (1 MHz) available channels
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps
	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric
Transmit Power	-6 dBm to 4 dBm (Bluetooth Class II)
Receiver Sensitivity	Better than -80 dBM at 0.1 % raw bit error rate
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Sleep <17 mW
Antenna	Internally integrated within module
Range	Up to 33 ft (10 m)
Electrical Interface	USB 2.0 compliant Microsoft Windows Plug and Play compliant
Bluetooth Software Supported	Broadcom Bluetooth for Windows Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions



Technical Specifications

Power Management	Microsoft Windows ACPI, and USB Bus Support Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Certifications	All necessary regulatory approvals for supported countries, including: FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	Generic Access Profile (GAP) Service Discovery Application Profile (SDAP) Serial Port Profile (SPP) Dial_Up Networking Profile (DUN) Generic Object Exchange Profile (GOEP) Object Push Profile (OPP) File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) Personal Area Networking Profile (PAN) Human Interface Device Profile (HID) Generic Audio/Video Distribution Profile (GAVDP) Advanced Audio/Video Distribution Profile (A2DP) FAX Profile (FAX) Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HFP) Basic Printing Profile (BPP) VDP (Video Distribution Profile)

AUDIO/MULTIMEDIA

Audio		
Hardware	Implementation	Realtek ALC3201-GR High Definition audio
	Volume Controls	Up, down, and mute function keys
	Full Duplex	Yes
	Microphone In	Stereo
	Headphone/Line Out	Stereo
	Integrated Microphone	Yes
Audio Output Quality	Frequency Response	10 Hz ~ 22 KHz
	Signal to Noise Ratio	Typical 95 dB FSA (DAC)
	Total Harmonic Distortion	Typical -88 dB FS (DAC)
	Noise Floor	-110 dB
	Play/Record Sampling Rate(s)	Up to 192 KHz
	DAC	24 bits
	ADC	24 bits



Technical Specifications

Internal Stereo	Power Rating	1.5 W
Speakers	Impedance	4 ohms

Multimedia

Integrated HD Webcam Supports videoconferencing and still image capture Improved quality for video streaming and still image capture (1280x720 resolution) Up to 30 frames/sec Fixed focus lens

POWER

HP 65W AC Adapter	Dimensions Weight Input	4.21 x 1.85 x 1.18 in (10.7 x 4.7 x 3.0 cm) 0.62 lb (280 g) 100 to 240 VAC	
	•	Input Efficiency	87% min at 115 VAC
		Input frequency range	47 to 63 Hz
		Input AC current	1.7 A at 90 VAC
	Output	Output power	65W
		DC output	18.5/19.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<11A, Over voltage protection- 29V max automatic shutdown
	Connector	3 pin/grounded, mates with interchangeable cords	
	Environmental Design	Operating temperature	41° to 95° F (5° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 5,000 ft (0 to 1,524 m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	safety standards - IEC60 Agency approvals - C-UL	e with LVD and EMC directives; Worldwide 950, EN60950, UL60950, Class1, SELV; -US, NORDICS, DENAN, EN55022 Class B, Class B, CCC, NOM-1 NYCE; MTBF - over mbient condition.



Technical Specifications

6-Cell (47 WHr) Lithium-Ion battery	Dimensions (h x w x l)	0.85 x 2.06 x 8.07 in (2.17 x 5.23 x 20.5 cm)		
	Weight	0.7 lb (0.327 kg)		
	Cells/Type	6-cell Lithium-Ion		
	Energy Temperature	Watt-hour capacity	47 WHr	
		Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 140° F (-10° to 60° C)	
		Non-operating	-4° to 140° F (-20° to 60° C)	
	Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours	
		System ON	3 to 5 hours (depending on system power consumption)	
		HP Fast Charge Technology	Charges the battery up to 90% within 90 minutes when system is OFF	

ENVIRONMENTAL

Environmental Data

Eco-Label Certifications	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:		
	US Energy Star ® IT ECO declaration EPEAT Silver		
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a "Typically Configured Notebook"		
Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	10.23 W	10.46 W	10.01 W
Sleep (Energy Star low power mode)	0.64 W	0.67 W	0.64 W
Off	0.37 W	0.40 W	0.36 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	35 BTU/hr	36 BTU/hr	34 BTU/hr
Sleep	2 BTU/hr	2 BTU/hr	2 BTU/hr
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr
	* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.		
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		
System Fan Off	Sound Power (LWAd, bels)		Sound Pressure (LpAm, decibels)
Idle	3.5		28
Fixed Disk (random writes)	3.5		28



Technical Specif	ications	
	System fan is usua Batteries	ally off except when charging the battery This battery(s) in this product comply with EU Directive 2006/66/EC
	Datteries	Batteries used in the product do not contain:
		 Mercury greater the 5ppm by weight
		Cadmium greater than 10ppm by weight
		The battery type and chemistry used in the product is:
		CR2032 (common) (Li-MNO2) = PANDA CR2032 lithium/manganese dioxide
	Additional information	This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.
		This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
		This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
		This product is in compliance with the IEEE 1680 (EPEAT) standard a the Silver level, see www.epeat.net
		Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
		This product contains 0% post-consumer recycled plastic (by wt.)
		This product is greater than 97.10% recycle-able when properly disposed of at end of life.
		Packaging Materials
		 External: PAPER/Corrugated 470.8 g Internal: PLASTIC/Polyethylene low density 46.3 g The PAPER/Corrugated packing material is made from 70% recycled content The PLASTIC/Polyethylene low density packing materials contains at least 50% recycled content
		HP follows these guidelines to decrease the environmental impact of product packaging:
		 Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials i packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469

Technical Specifications

and DIN 6120 standards.

MATERIAL USAGE

This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the Environment

(http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
- Nickel finishes that release greater than 0.5 µgrams/cm²/week, measured according to EN 1811:1998, are not used on any product surface designed to be frequently handled or touched by users.

END-OF-LIFE MANAGEMENT AND RECYCLING

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well a HP OEM customers who integrate and re-sell HP equipment.

HEWLETT-PACKARD CORPORATE ENVIRONMENTAL INFORMATION

For more information about HP's commitment to the environment:

Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Environment website http://www.hp.com/environment Eco-label certifications http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html



Technical Specifications

COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

NOTE: Options/capabilities listed in the QuickSpecs represent those capabilities available through Base Units or Build to Order configurations. The various product features and capabilities will vary in terms of configurable vs. aftermarket options (AMOs). There may be options and capabilities available through CTO that are not available as AMOs.

Туре	Description	Part #	
Carrying Cases	HP Essential Top Load Case (up to 15.6")	H2W17AA#xxx	
	HP Essential Backpack (up to 15.6") HP Business 4 Wheel Roller Case	H1D24AA H5M93AA	
Decking	LID LICD 2.0 Part Danliastor		
Docking	HP USB 2.0 Port Replicator HP USB 3.0 Port Replicator	H1L07AA#xxx H1L08AA#xxx	
Input/Output	HP Stylish Wireless KB/Mouse	H4B79AA	
	HP Stylish USB KB/Mouse	H4B80AA	
Memory	HP 4GB DDR3 1600 PC3-12800 SODIMM	H2P64AA#xxx	
Adapters	90W Slim Combo Adapter	H4A41AA#xxx	
	90W w/USB Universal Adapter	H4A43AA#ABA	
	90W Smart Auto/Truck Adapter	ED493AA	
	HP 65W Slim Adapter	AX727AA#xxx	
Batteries	HP MU06 Battery	H0F74AA#ABA	
Security	HP Notebook Combo Lock	AY475AA#xxx	
	HP UltraSlim Keyed Cable Lock	H4D73AA	
Storage	HP Mobile USB DVDRW Non-LS	A2U57AA	

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